

## **BC214L**

### **PNP General Purpose Amplifier**

- This device is deisgned for use as general purpose amplifiers and switches requiring collector currents to 300mA.
- Sourced from process 68.



1. Emitter 2. Collector 3. Base

### **Absolute Maximum Ratings\*** T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CEO</sub>	Collector-Emitter Voltage	-30	V
V <sub>CBO</sub>	Collector-Base Voltage	-45	V
V <sub>EBO</sub>	Emitter-Base Voltage	-5.0	V
I <sub>C</sub>	Collector Current (DC) Continuous	-500	mA
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	- 55 ~ 150	°C

<sup>\*</sup> These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

- These ratings are based on a maximum junction temperature of 150 degrees C.
   These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations

### **Electrical Characteristics** $T_a$ =25°C unless otherwise noted

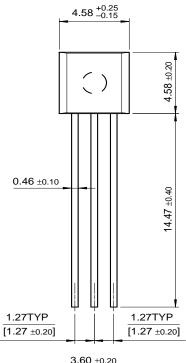
Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Characte	eristics	•			•
V <sub>(BR)CEO</sub>	Collector-Emitter Voltage	$I_{C} = -2mA, I_{B} = 0$	-30		V
V <sub>(BR)CBO</sub>	Collector-Base Voltage	$I_{C} = -10\mu A, I_{E} = 0$	-45		V
V <sub>(BR)EBO</sub>	Emitter-Base Voltage	$I_E = -10\mu A, I_C = 0$	-5.0		V
I <sub>CBO</sub>	Collector Cut-off Current	$V_{CB} = -30V, I_{E} = 0$		-15	nA
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{EB} = -4V, I_{C} = 0$		-15	nA
On Characte	eristics *	•			•
h <sub>FE</sub>	DC Current Gain	$V_{CE} = -5V, I_{C} = -10\mu A$ $V_{CE} = -5V, I_{C} = -2mA$ $V_{CE} = -5V, I_{C} = -100mA$	100 140 120	400	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	$I_C = -10 \text{mA}, I_B = -0.5 \text{mA}$ $I_C = -100 \text{mA}, I_B = -5 \text{mA}$		-0.25 -0.6	V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage	$I_C = -100 \text{mA}, I_B = -5 \text{mA}$		-1.1	V
V <sub>BE</sub> (on)	Base-Emitter On Voltage	$V_{CE} = -5V, I_{C} = -2mA$	-0.6	-0.72	V
Small Signa	I Characteristics	•			•
f <sub>T</sub>	Current gain Bandwidth Product	V <sub>CE</sub> = -5V, I <sub>C</sub> = -10mA f = 100MHz	200		MHz
NF	Noise Figure	$V_{CE} = -5V, I_{C} = -200\mu A$ $R_{G} = 2k\Omega, f = 15.7KHz$		2.0	dB
h <sub>fe</sub>	Small Signal Current Gain	$I_C = -2mA$ , $V_{CE} = -5V$ f = 1KHz	140		
C <sub>OB</sub>	Output Capacitance	V <sub>CB</sub> = -10V, f = 1MHz		10	pF

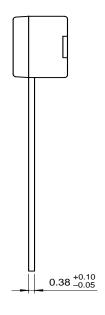
<sup>\*</sup> Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2.0%

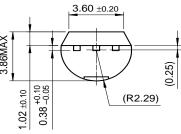
Thermal Characteristics T <sub>A</sub> =25°C unless otherwise noted			
Symbol	Parameter	Max.	Units
P <sub>D</sub>	Total Device Dissipation Derate above 25°C	625 5.0	mW mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	°C/W

# **Package Dimensions**

TO-92







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